


APPLICATION DATA SHEET

Electronic Version

Stylesheet Version v14.0

Title of Invention	TFI PROBE I/O WRAP TEST METHOD	
Application Type : regular, Attorney Docket Number : 21806-00146-US1		
Correspondence address: Customer Number: 30678		
		
Continuing Data: This is a Division of US application number 10035186, filed 2002-01-04. This is a Division of US application number 09615198, filed 2000-07-13.		
Inventors Information: <u>Inventor 1:</u> Applicant Authority Type: Inventor Citizenship: IN Given Name: Gobinda Family Name: Das Residence: City of Residence: Hopewell Junction State of Residence: NY Country of Residence: US Address-1 of Mailing Address: 105 Orchard Lane Address-2 of Mailing Address: City of Mailing Address: Hopewell Junction State of Mailing Address: NY Postal Code of Mailing Address: 12533 Country of Mailing Address: US Phone: Fax: E-mail:		

Inventor 2:

Applicant Authority Type: Inventor
Citizenship: US
Given Name: Franco
Family Name: Motika
Residence:
City of Residence: Hopewell Junction
State of Residence: NY
Country of Residence: US
Address-1 of Mailing Address: 145 Clove Branch Road
Address-2 of Mailing Address:
City of Mailing Address: Hopewell Junction
State of Mailing Address: NY
Postal Code of Mailing Address: 12533
Country of Mailing Address: US
Phone:
Fax:
E-mail:

Publication Information:
Suggested Figure for Publication - 7B
Suggested Classification -
Suggested Technology Center -
Total Number of Drawing Sheets - 7

Assignee 1:

Organization Name: International Business Machines Corporation
Address-1 of Mailing Address: New Orchard Road
Address-2 of Mailing Address:
City of Mailing Address: Armonk
State of Mailing Address: NY
Postal Code of Mailing Address: 10504
Country of Mailing Address: US
Phone:
Fax:
E-mail: